

**Capital Tape Co, Inc**  
**4920 Commerce Parkway #11**  
**Cleveland, OH 44128**  
**Fax: 887-893-3337**



## **T-Bond II® V2200**

Semi-rigid polyurethane foam substrate used as a structural glazing and cladding spacer system for in-shop fabrication. Speeds shop fabrication of unitized panels. Easy to handle and suitable for die cutting.

### **PHYSICAL PROPERTIES:**

Thickness	V2204	.125"
	V2206	.188"
	V2208	.250"
	V2210	.313"
	V2212	.375"
Density	ASTM D-1667	22 lbs./ cu ft
Hardness, Shore A	ASTM D-2240	30
Tensile Strength	ASTM D-412	130 p.s.i.
Elongation	ASTM D-412	105%
Dynamic Tensile Adhesion	45 p.s.i.	15 minute dwell
Dynamic Shear Adhesion	30 p.s.i.	15 minute dwell
Static Shear Adhesion	2000+ hours	1 psi load
Thermal Conductivity K factor: BTU*in/hr*ft <sup>2</sup> *°F (w/m*°C)	.55	ASTM C-518
Recommended Service Temperature:		-40°F (-40°C) to 180°F(82°C)
Recommended Application Temperature		60°F(16°C) to 125°F(52°C)

These are approximate values and do not constitute a warranty. It is the customer's responsibility to determine these products fitness for use in the intended end use application. Test data contained herein is believed to be reliable and it is not stated as, or to be taken as, a specification for these products. T-Bond II V2200 is a spacer material and is not intended to be a structural component.